

PHASE CONTROL SCR

Description/Features

The 25TTS.. new series of silicon controlled rectifiers are specifically designed for medium power switching and phase control applications. The glass passivation technology used has reliable operation up to 125° C junction temperature.

Typical applications are in input rectification (soft start) and these products are designed to be used with International Rectifier input diodes, switches and output rectifiers which are available in identical package outlines.

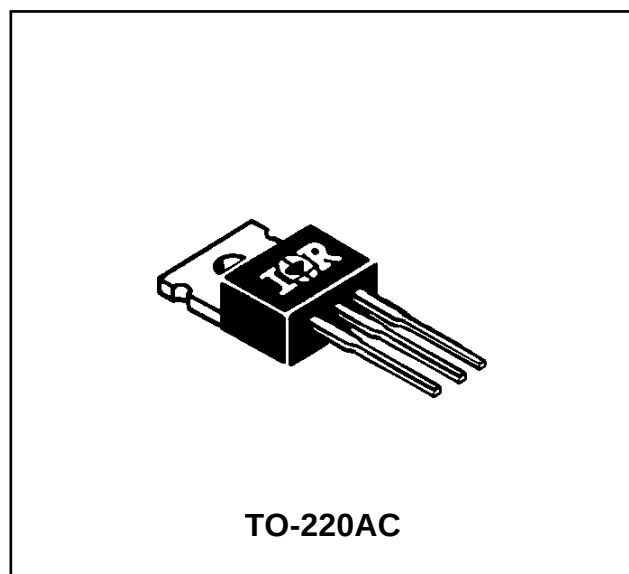
	V_T	$< 1.25V @ 16A$
	I_{TSM}	$= 200A$
	V_R/V_D	$= 1600V$

Output Current in Typical Applications

Applications	Single-phase Bridge	Three-phase Bridge	Units
Capacitive input filter $T_A = 55^\circ C, T_J = 125^\circ C$, common heatsink of $1^\circ C/W$	18	22	A

Major Ratings and Characteristics

Characteristics	25TTS..	Units
$I_{T(AV)}$ Sinusoidal waveform	16	A
I_{RMS}	25	A
V_{RRM}/V_{DRM}	up to 1600	V
I_{TSM}	250	A
V_T @ 16 A, $T_J = 25^\circ C$	1.25	V
dv/dt	500	V/ μs
di/dt	150	A/ μs
T_J	-40 to 125	$^\circ C$



Also available in SMD-220 package (series 25TTS..S)

Voltage Ratings

Part Number	V_{RRM} , maximum peak reverse voltage V	V_{DRM} , maximum peak direct voltage V	I_{RRM}/I_{DRM} 125°C mA
25TTS08	800	800	5
25TTS12	1200	1200	
25TTS16	1600	1600	

Absolute Maximum Ratings

Parameters		25TTS..	Units	Conditions	
I _{T(AV)}	Max. Average On-state Current	16	A	50% duty cycle @ T _C = 90° C, sinusoidal wave form	
I _{RMS}	Max. RMS On-state Current	25			
I _{TSM}	Max. Peak One Cycle Non-Repetitive	210		10ms Sine pulse, rated V _{RRM} applied	
	Surge Current	250		10ms Sine pulse, no voltage reapplied	
I ² t	Max. I ² t for fusing	220	A ² s	10ms Sine pulse, rated V _{RRM} applied	
		310		10ms Sine pulse, no voltage reapplied	
I ² √t	Max. I ² √t for fusing	3100	A ² √s	t=0.1 to 10ms, no voltage reapplied	
V _{TM}	Max. On-state Voltage Drop	1.25	V	@ 16A, T _J = 25°C	
r _t	On-state slope resistance	12.0	mΩ	T _J = 125°C	
V _{T(TO)}	Threshold Voltage	1.0	V		
I _{RM} /I _{DM}	Max.Reverse and Direct	0.5	mA	T _J = 25 °C	V _R = rated V _{RRM} / V _{DRM}
	Leakage Current	5.0		T _J = 125 °C	
I _H	Max. Holding Current	100	mA	Anode Supply = 6V, Resistive load, Initial I _T =1A	
I _L	Max. Latching Current	200	mA	Anode Supply = 6V, Resistive load	
dv/dt	Max. rate of rise of off-state Voltage	500	V/μs		
di/dt	Max. rate of rise of turned-on Current	150	A/μs		

Triggering

Parameters	25TTS..	Units	Conditions
P_{GM} Max. peak Gate Power	8.0	W	
$P_{G(AV)}$ Max. average Gate Power	2.0		
$+ I_{GM}$ Max. peak positive Gate Current	1.5	A	
$- V_{GM}$ Max. peak negative Gate Voltage	10	V	
I_{GT} Max. required DC Gate Current to trigger	60	mA	Anode supply = 6V, resistive load, $T_J = -10^{\circ}\text{C}$
	45		Anode supply = 6V, resistive load, $T_J = 25^{\circ}\text{C}$
	20		Anode supply = 6V, resistive load, $T_J = 125^{\circ}\text{C}$
V_{GT} Max. required DC Gate Voltage to trigger	2.5	V	Anode supply = 6V, resistive load, $T_J = -10^{\circ}\text{C}$
	2.0		Anode supply = 6V, resistive load, $T_J = 25^{\circ}\text{C}$
	1.0		Anode supply = 6V, resistive load, $T_J = 125^{\circ}\text{C}$
V_{GD} Max. DC Gate Voltage not to trigger	0.25		$T_J = 125^{\circ}\text{C}$, $V_{DRM} = \text{rated value}$
I_{GD} Max. DC Gate Current not to trigger	2.0	mA	$T_J = 125^{\circ}\text{C}$, $V_{DRM} = \text{rated value}$

Switching

Parameters	25TTS..	Units	Conditions
t_{gt} Typical turn-on time	0.9	μs	$T_J = 25^{\circ}\text{C}$
t_{rr} Typical reverse recovery time	4		$T_J = 125^{\circ}\text{C}$
t_q Typical turn-off time	110		

Thermal-Mechanical Specifications

Parameters			25TTS..	Units	Conditions
T _j	Max. Junction Temperature Range		- 40 to 125	°C	
T _{stg}	Max. Storage Temperature Range		- 40 to 125		
R _{thJC}	Max. Thermal Resistance Junction to Case		1.1	°C/W	DC operation
R _{thJA}	Max. Thermal Resistance Junction to Ambient		62		
R _{thCS}	Typ. Thermal Resistance Case to Ambient		0.5		Mounting surface, smooth and greased
wt	Approximate Weight		2 (0.07)	g (oz.)	
T	Mounting Torque	Min.	6 (5)	Kg-cm (lbf-in)	
		Max.	12 (10)		
Case Style			TO-220AC		

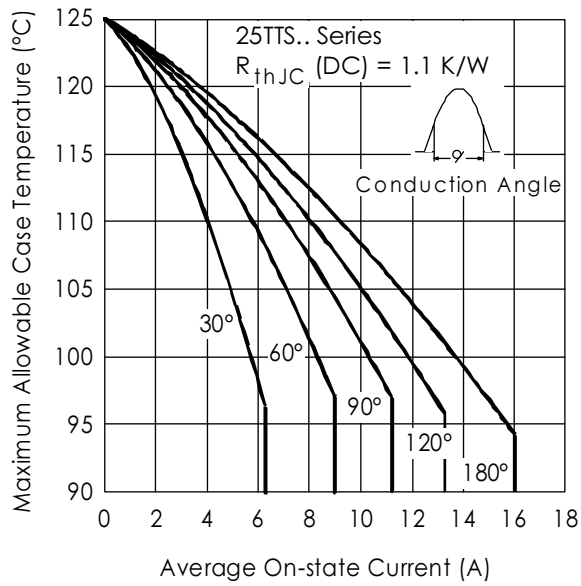


Fig. 1 - Current Rating Characteristics

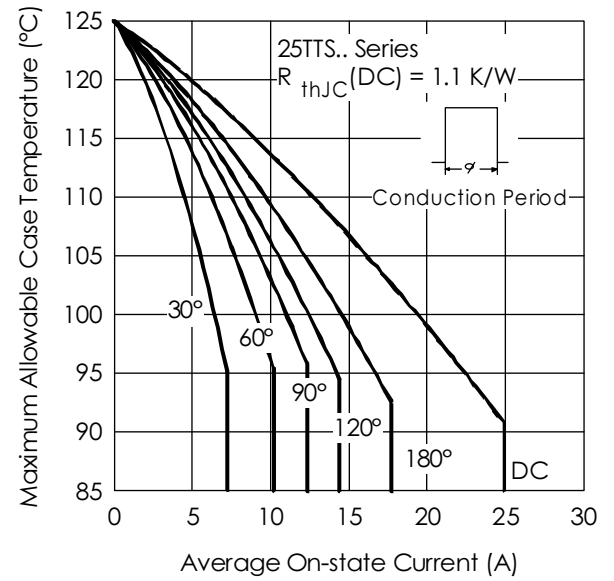


Fig. 2 - Current Rating Characteristics

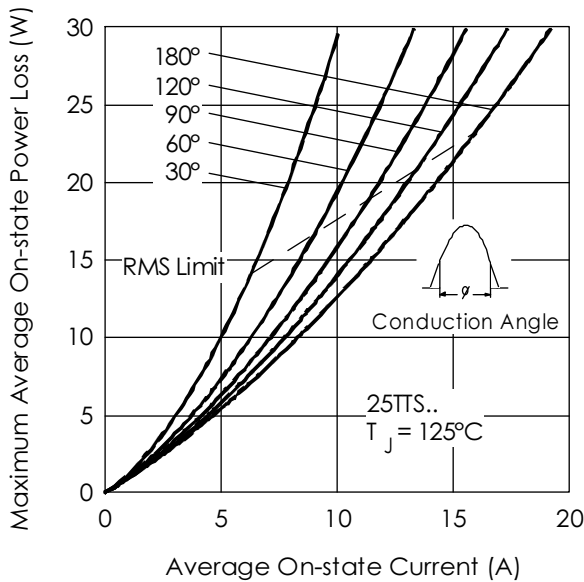


Fig. 3 - On-state Power Loss Characteristics

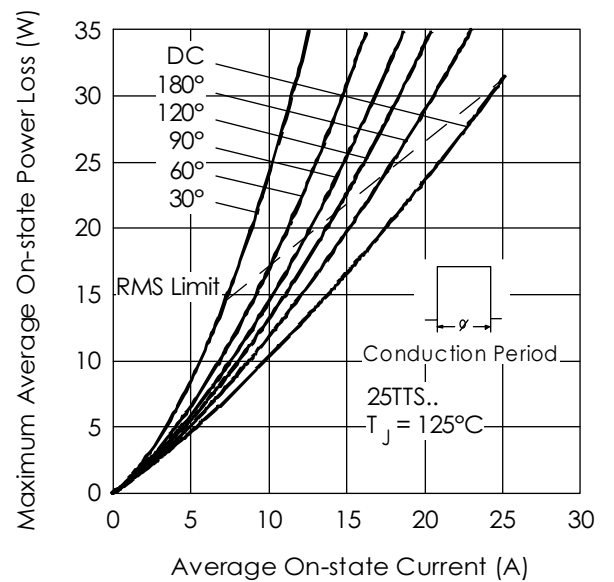


Fig. 4 - On-state Power Loss Characteristics

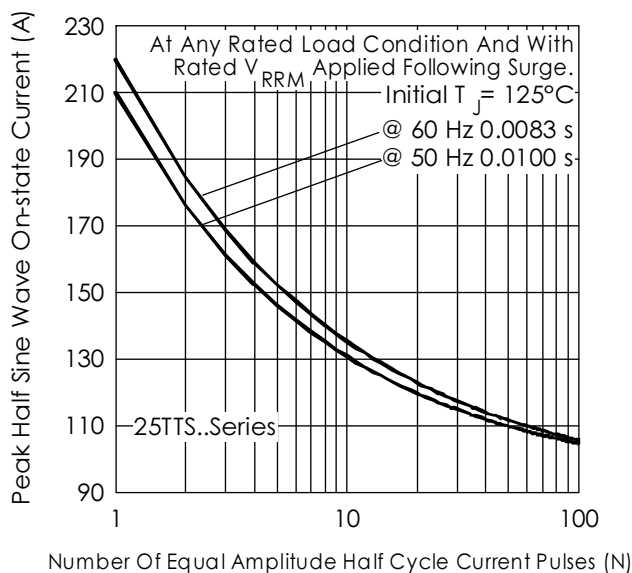


Fig. 5 - Maximum Non-Repetitive Surge Current

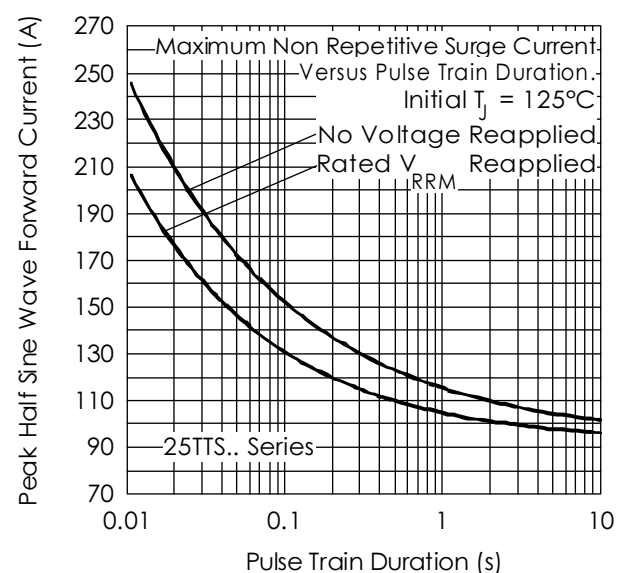


Fig. 67 - Maximum Non-Repetitive Surge Current

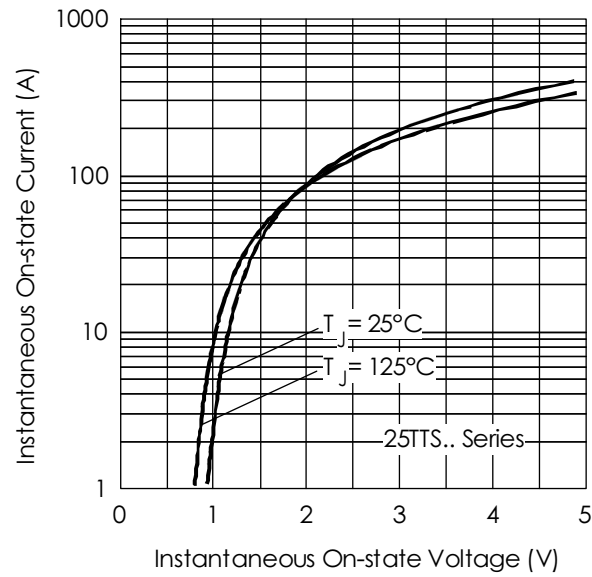


Fig. 7 - On-state Voltage Drop Characteristics

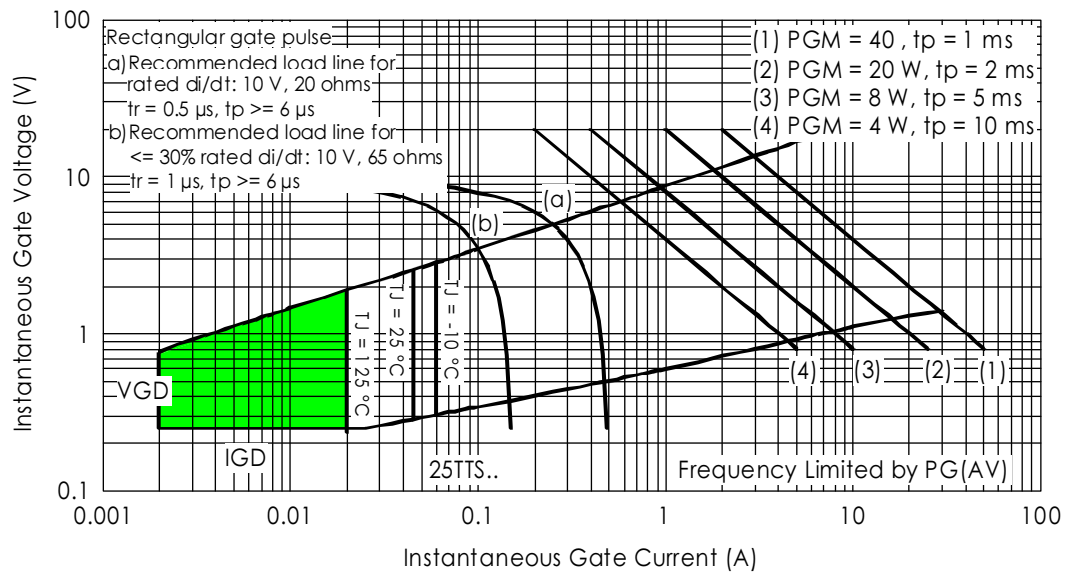
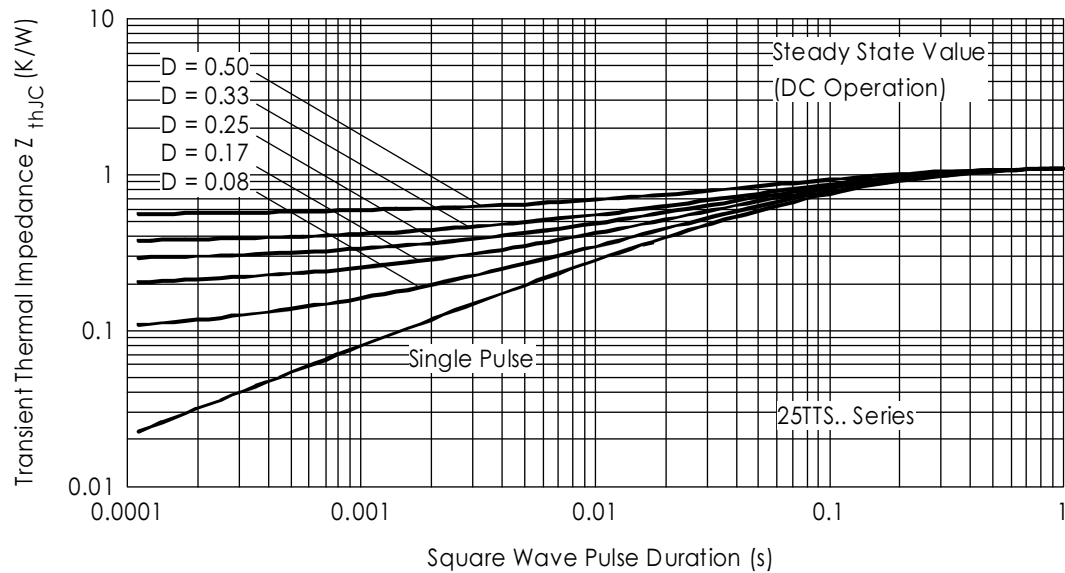
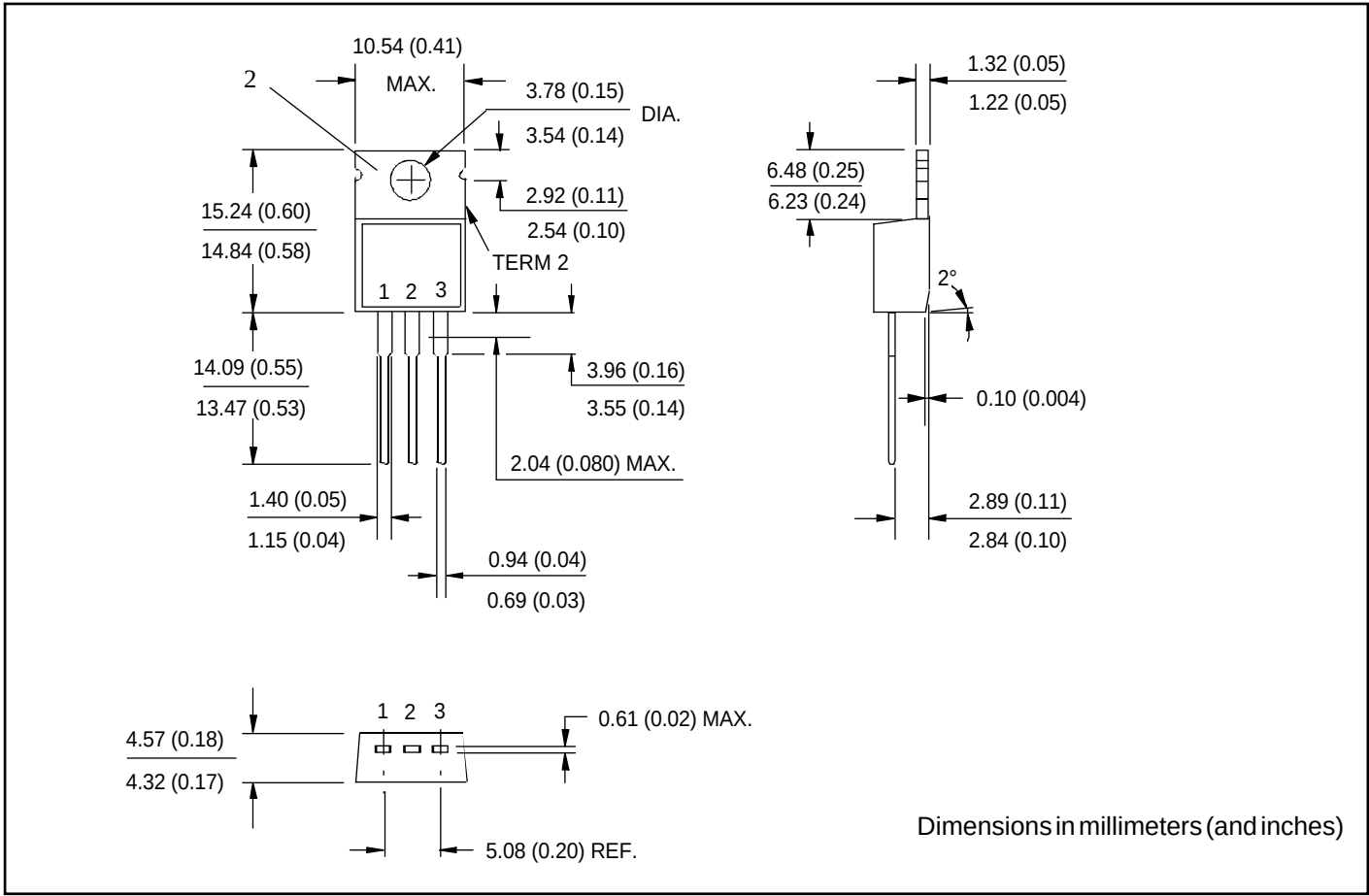


Fig. 8 - Gate Characteristics


Fig. 9 - Thermal Impedance Z_{thJC} Characteristics

Outline Table



Ordering Information Table

